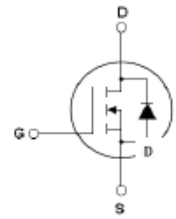


## Main Product Characteristics

$V_{DSS}$	100V
$R_{DS(on)}$	0.15 $\Omega$ (typ)
$I_D$	3A



SOT-223



Schematic Diagram

## Description

The SSF0115 is a new generation of high voltage and low current N-Channel enhancement mode trench power MOSFET. This new technology increases the device reliability and electrical parameter repeatability.

## Features and Benefits

- Advanced trench process technology
- Avalanche energy, 100% tested
- Fully characterized avalanche voltage and current

## Application

- IEEE802.3AF Compatible

## Absolute Maximum Ratings

Symbol	Parameter	Max.	Units
$I_D@T_c=25^\circ\text{C}$	Continuous Drain Current, $V_{GS}@10\text{V}$	3	A
$I_D@T_c=100^\circ\text{C}$	Continuous Drain Current, $V_{GS}@10\text{V}$	2.3	
$I_{DM}$	Pulsed Drain Current ①	12	
$P_D@T_c=25^\circ\text{C}$	Power Dissipation	2.1	W
	Linear Derating Factor	0.019	W/°C
$V_{GS}$	Gate-to-Source Voltage	$\pm 20$	V
$E_{AS}$	Single pulse Avalanche Energy ②	79	mJ
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to +175	°C

## Thermal Resistance

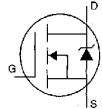
Symbol	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JA}$	Junction-to-Ambient	—	—	69	°C/W

\*When mounted on the minimum pad size recommended (PCB Mount)

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Sym.	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$BV_{DSS}$	Drain-to-Source Breakdown Voltage	100	—	—	V	$V_{GS}=0V, I_D=250\mu A$
$R_{DS(on)}$	Static Drain-to-Source On-resistance	—	0.09	0.15	$\Omega$	$V_{GS}=10V, I_D=2A$
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS}=V_{GS}, I_D=250\mu A$
$I_{DSS}$	Drain-to-Source Leakage Current	—	—	1	$\mu A$	$V_{DS}=30V, V_{GS}=0V$
		—	—	10		$V_{DS}=100V, V_{GS}=0V, T_J=150^\circ\text{C}$
$I_{GSS}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{GS}=20V$
	Gate-to-Source reverse Leakage	—	—	-100		$V_{GS}=-20V$
$Q_g$	Total Gate Charge	—	18	22	nC	$I_D=9.2A, V_{GS}=10V$ $V_{DD}=80V, R_L=8.6\Omega$
$Q_{gs}$	Gate-to-Source Charge	—	2.7	—		
$Q_{gd}$	Gate-to-Drain("Miller") Charge	—	7.8	—		
$t_{d(on)}$	Turn-on Delay Time	—	12	40	nS	$V_{DD}=50V$ $I_D=9.2A, R_L=5.4\Omega$ $R_G=18\Omega$ $V_{GS}=10V$
$t_r$	Rise Time	—	12	40		
$t_{d(off)}$	Turn-Off Delay Time	—	33	85		
$t_f$	Fall Time	—	26	68		
$C_{iss}$	Input Capacitance	—	350	480	pF	$V_{GS}=0V$ $V_{DS}=25V$ $f=1.0\text{MHz}$
$C_{oss}$	Output Capacitance	—	90	110		
$C_{rss}$	Reverse Transfer Capacitance	—	35	45		

**Source-Drain Ratings and Characteristics**

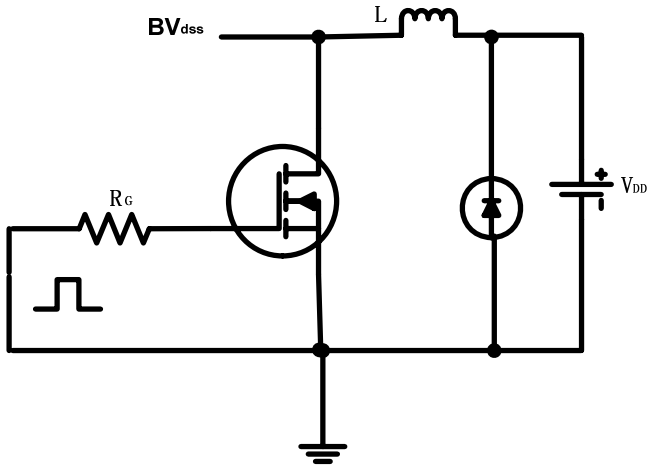
Sym.	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	3	A	MOSFET symbol showing the integral reverse p-n junction diode. 
$I_{SM}$	Pulsed Source Current (Body Diode) ①	—	—	18		
$V_{SD}$	Diode Forward Voltage	—	—	1.3	V	$T_J=25^\circ\text{C}, I_S=3A, V_{GS}=0V$ ③
$t_{rr}$	Reverse Recovery Time	—	98	—	nS	$T_J=25^\circ\text{C}, I_F=9.2A$
$Q_{rr}$	Reverse Recovery Charge	—	0.34	—	$\mu C$	$di/dt=100A/\mu s$ ③
$t_{on}$	Forward Turn-on Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$ )				

**Notes:**

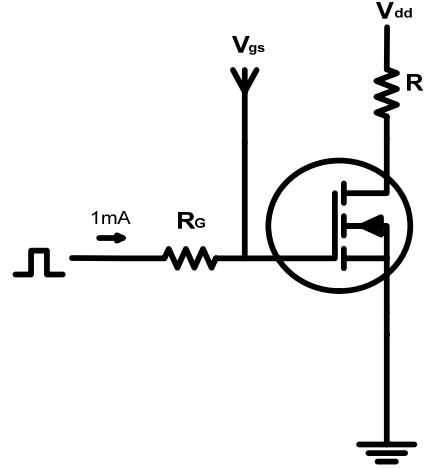
- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Test condition:  $L = 30\text{mH}, V_{DD} = 50V, I_d = 2.3A$
- ③ Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 1.5\%$ ;  $R_G = 25\Omega$  Starting  $T_J = 25^\circ\text{C}$

**Test Circuits and Waveforms**

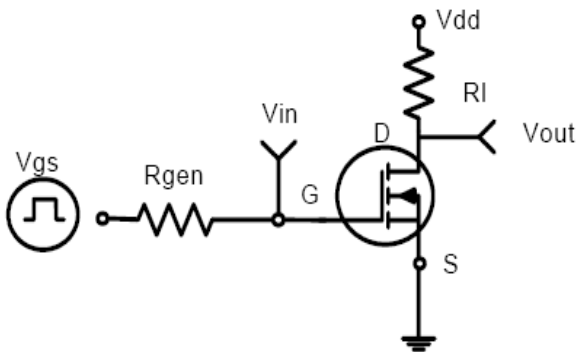
**E<sub>AS</sub> Test Circuit**



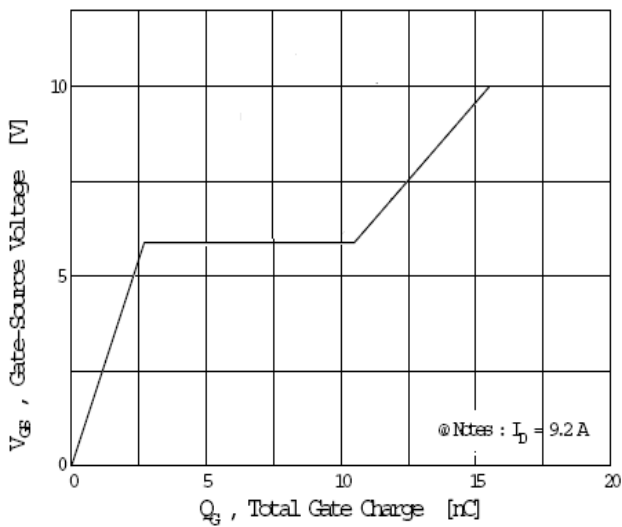
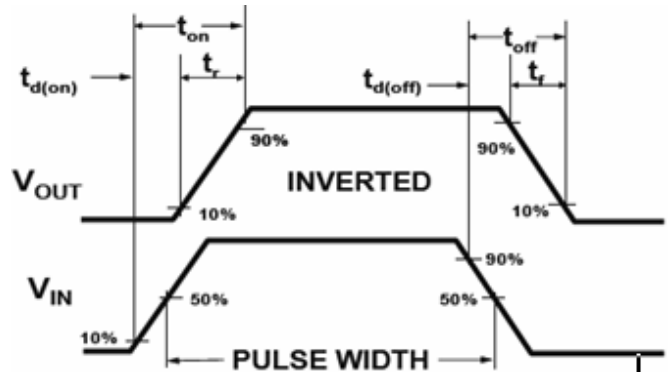
**Gate Charge Test Circuit**



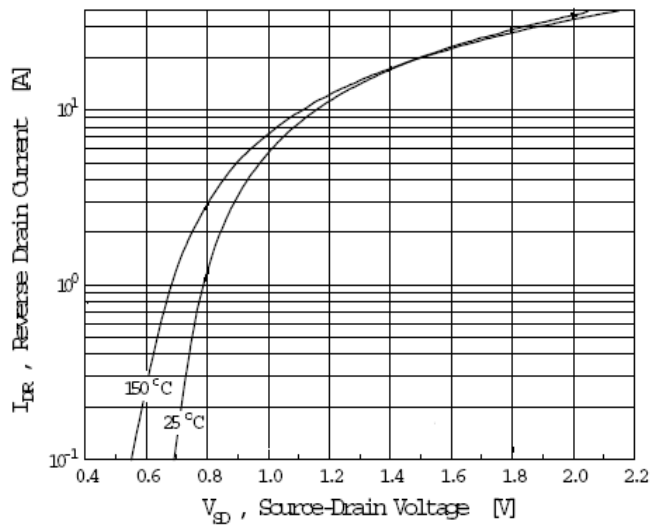
**Switching Time Test Circuit**



**Switching Waveform**

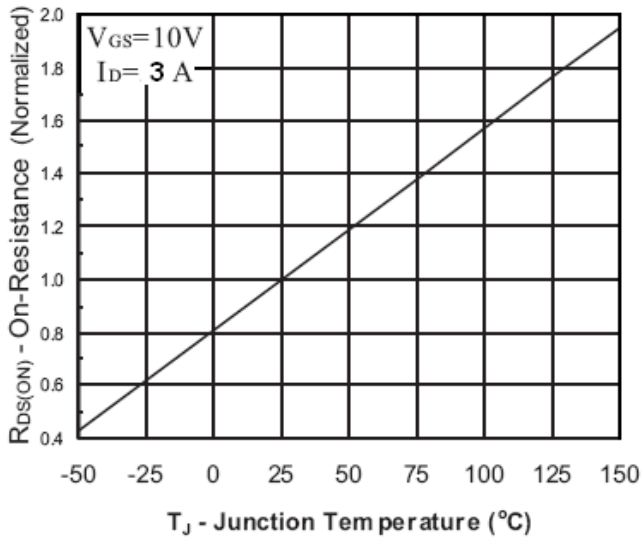


**Gate Source Voltage vs Total Gate Charge**

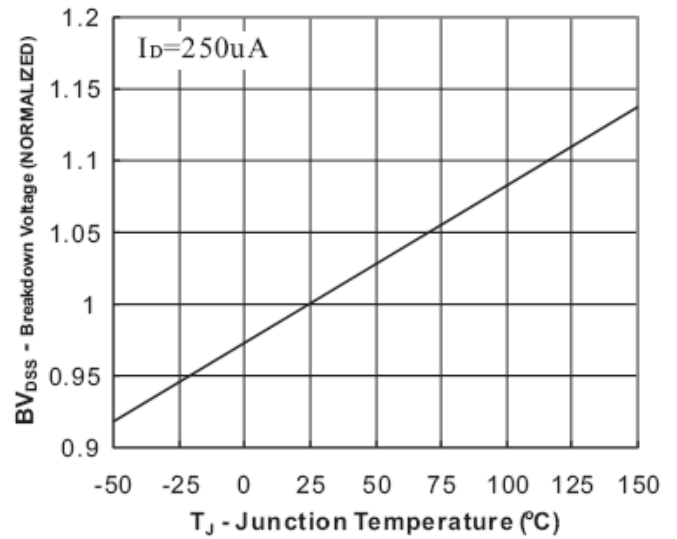


**Source-Drain Diode Forward Voltage**

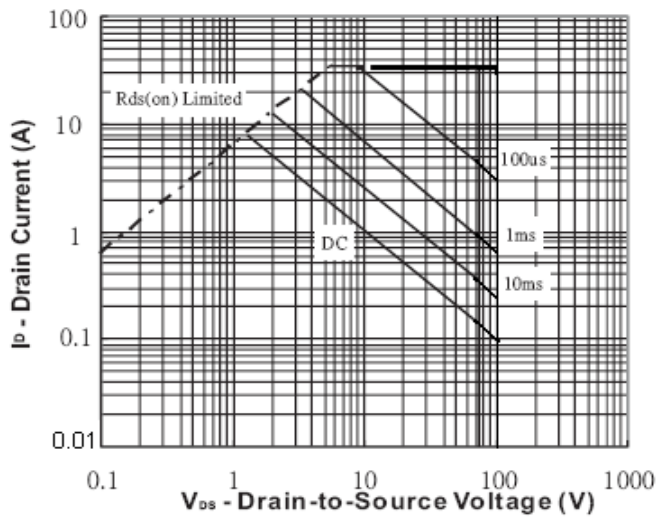
**Typical Electrical and Thermal Characteristics**



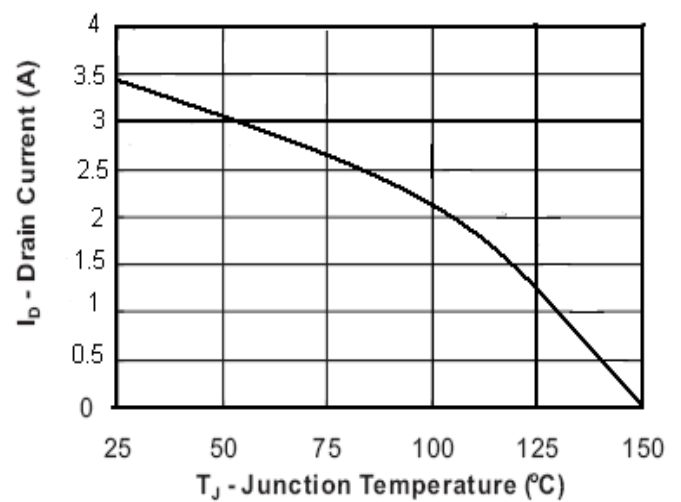
**On Resistance vs Junction Temperature**



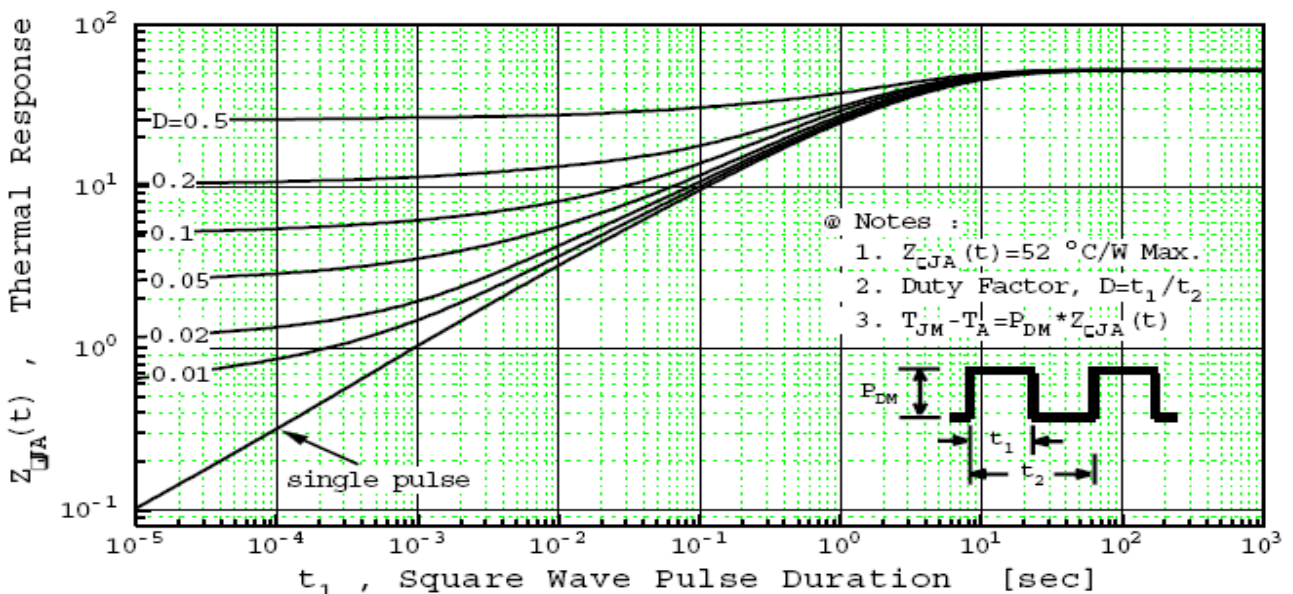
**Breakdown Voltage vs Junction Temperature**



**Safe Operation Area**

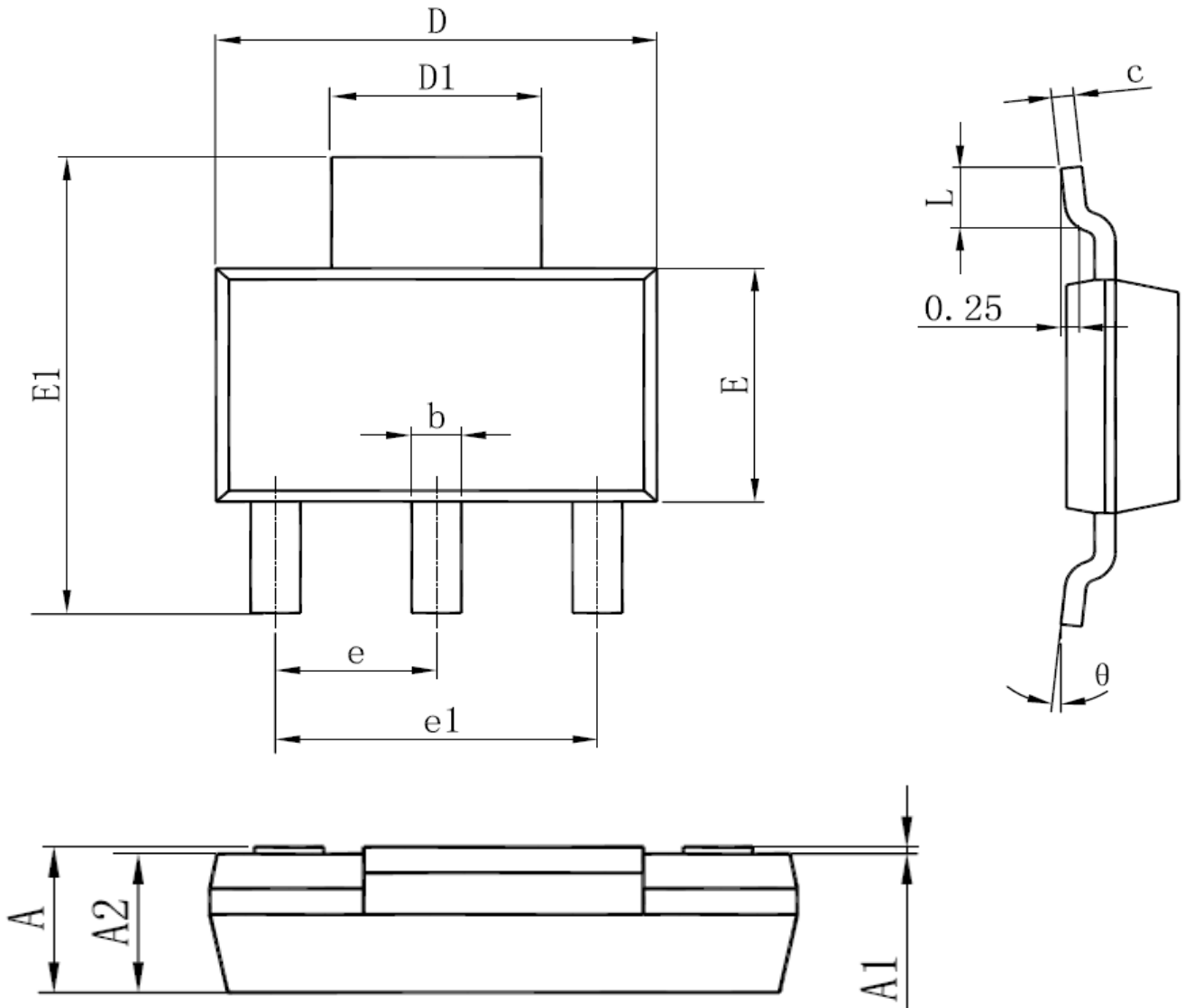


**Max Drain Current vs Junction Temperature**



**Transient Thermal Impedance Curve**

**SOT-223 MECHANICAL DATA**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.520	1.800	0.060	0.071
A1	0.000	0.100	0.000	0.004
A2	1.500	1.700	0.059	0.067
b	0.660	0.820	0.026	0.032
c	0.250	0.350	0.010	0.014
D	6.200	6.400	0.244	0.252
D1	2.900	3.100	0.114	0.122
E	3.300	3.700	0.130	0.146
E1	6.830	7.070	0.269	0.278
e	2.300(BSC)		0.091(BSC)	
e1	4.500	4.700	0.177	0.185
L	0.900	1.150	0.035	0.045
θ	0°	10°	0°	10°